# Effects of Heat-Treatment Processes on the Electroless Ni-B Coating and its Natural Aging Mechanism

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#### INTRODUCTION

Electroless plating with its many advantages, such as uniform deposition on complex and intricately shaped parts, the possibility of metallizing non-conductors, and the ability to plate selectively draws world wide attention. Compared with electroless Ni-P alloy, Ni-B alloy has features of higher hardness, good wear-resistance and solderability, etc. It has been widely used in the fields of automotive, aerospace and electronic industry. As an efficient and cheap method to prepare surface protection coatings with high properties, electroless Ni-B has promising future prospects.

Dimethylamineborane (DMAB) and sodium borohydride are two common reducing agents for electroless Ni-B alloy1.2. DMAB is used for plating from weak acidic to strong alkaline conditions. The deposits made from this reductant contain boron within the range of  $0.1\sim5$  wt%, and possess some specific characteristics such as good solderability and electrical conductivity. This kind of deposit is mainly applied in the electronics industry3. Sodium borohydride reductant is used under strong alkaline conditions4. Deposits with 3~8 wt% boron content can be obtained. This kind of deposit is known for high hardness, good wearresistance and corrosion-resistance. Although numerous papers about the properties and

SUMMARY – A Ni-B coating was prepared with EN using potassium borohydride reducing agent. The asplated micro-structure of the coating was confirmed from XRD to be a mixture of amorphous and supersaturated solid solution. Three kinds of phase transformation were observed from the DSC curve. Different from the previous works, the formation of Ni B, and Ni B was found during some transformation processes. The key factors which influence the variation of micro-hardness and micro-structure in deposits are the formation, the size and amount of Ni B, Ni B, and Ni B. Aging of the deposits treated under some heat treatment conditions occurred at room temperature. Changes of micro-hardness indicated aging phenomena evidently. The natural aging phenomena are concerned with various kinds of decomposition of borides, especially with Ni B, phase. The extent of natural aging depends on the formation and the quantity of Ni B, and Ni B.

micro-structures of electroless Ni-B deposits have been published<sup>5-7</sup>, few of them have described the transformation mechanism of the deposits under heat-treatment, especially with relatively long duration. In the present paper, the deposits with 3.5~6.5 wt% boron content were prepared by electroless nickel using borohydridge reductant. The as-plated deposits with micro-hardness 750~800 VHN<sub>100</sub> comprised of microcrystalline and amorphous phases. The phase transformation of the deposits through various heat-treatment processes, its mechanism as well as natural aging characteristics are discussed in detail.

#### **EXPERIMENTAL**

#### Sample Preparation

The standard composition of the bath was NiCl<sub>2</sub>.6H<sub>2</sub>O: 30 g l<sup>-1</sup>, NH<sub>2</sub>CH<sub>2</sub>CH<sub>2</sub>NH<sub>2</sub>: 60 ml l<sup>-1</sup>, NaOH: 50 g l<sup>-1</sup> KBH<sub>4</sub>:  $0.8\sim1.2$  g l<sup>-1</sup>, stabilizer as it required. The pH value of the solution exceeded 13. The operating temperature was  $92\pm1^{\circ}$ C. Deposition rate was  $10\sim20$  µm/h<sup>-1</sup>. Deposition time was one hour.

To minimise substrate effects, 7Cr7Mo2V2Si alloy steel blocks with hardness of Hv 700~800 were used. The size of a coupon was 18 × 10 mm. All substrates were polished, alkaline cleaned, water cleaned, acid activated and de-ionized water rinsed before plating.

### Sample Testing

The boron content of samples was determined with an HITACHI 180 86 type atomic absorption spectrometer. The micro-structure of coatings was analyzed with a D/MAX A X-ray diffractometer. The micro-hardness of samples was measured with an HXD-1000 micro-hardness tester. The thermal analyses of samples were performed with a differential scanning calorimeter between room temperature and 500°C at a heating rate of 20°C min<sup>-1</sup>.

#### **RESULTS & DISCUSSION**

# Phase Transformation under Thermal Action

The micro-structure of an as-plated coating was explored with X-ray diffraction. The XRD pattern (Figure 1) of an as-plated deposit, consists of a broad peak and a superimposing sharp one. Accordingly, the micro-structure of the coating is a mixture of micro-crystalline and non-crystalline, and the main constitution of the micro-crystalline was probably a supersaturated solid solution of B in nickel<sup>5</sup>.

The phase transformations in the coating were characterized by differential scanning calorimeter (DSC) testing. A DSC curve of the deposit sample is shown in Figure 2. It has three manifest peaks on the curve which indicate three kinds of phase transition respectively. According to a previous paper<sup>1</sup>, Ni<sub>3</sub>B is formed at 350°C, Ni<sub>2</sub>B<sub>3</sub> is formed at 405°C. The DSC results in the present paper show three peaks occurring at 302.15°C, 307.65°C and 421.5°C. Further XRD analyses indicate that Ni<sub>4</sub>B, Ni<sub>2</sub>B and Ni<sub>4</sub>B<sub>3</sub> are formed at these temperatures, respectively.

The XRD patterns of coatings after 300°C. 400°C and 500°C heat treatment are shown in Figure 3. These patterns are very different from each other. Diffraction lines corresponding to Ni,B and {111}Ni are observed evidently in all three patterns. There are discernible peaks corresponding to {110} and {200} Ni,B planes in Figure 3(b) and (c) except those confused with Ni<sub>3</sub>B peaks. An unlapped peak of {202} plane Ni B, in Figure 3(c) is marked. Therefore, the micro-structure of the 300°C heat treatment coating consists of fcc Ni and Ni, B (Figure 3(a)), while that of the 400°C consists of fcc Ni, Ni,B and Ni,B (Figure 3(b)) and that of the 500°C consists of fcc Ni, Ni, B, Ni, B and Ni, B, (Figure 3(c)). It should be noted that the Ni B, phase appears among the nickel borides instead of the Ni.B. phase when the heat treatment temperature

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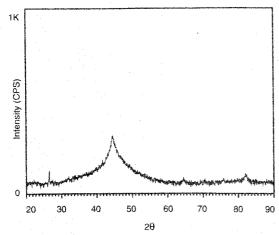


Figure 1. The XRD pattern of as-plated sample.

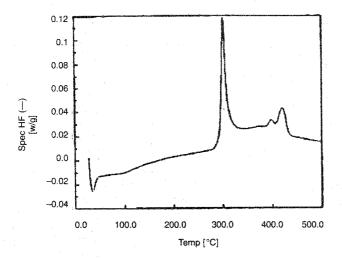


Figure 2. The DSC curve of Ni-B deposits.

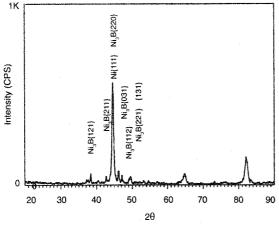


Figure 3(a). XRD pattern of a sample after 300°C × 1 h heat treatment.

was high enough. So combined with the DSC results, it can be confirmed that Ni<sub>3</sub>B is formed at about 302.1°C, Ni<sub>2</sub>B at about 397.65°C, and Ni<sub>4</sub>B<sub>3</sub> at about 421.5°C.

#### Heat Treatment Process and its Influence on the Micro-Structure and Micro-Hardness

From the DSC results, 300°C, 350°C, 400°C and 500°C were selected as heat treatment temperatures. These treating temperatures were chosen near to the three crystallization

temperatures of Ni-B alloy. Diversity of treatment duration was selected corresponding to different heat treatment temperatures. Longer duration was adopted for lower temperature treatments. The processing scheme is listed in Table I.

The variations of coating micro-hardness under different heat treatment conditions are shown in Figure 4. In general, micro-hardness variability of this kind of deposit relates to its micro-structure which is determined by the type of crystallization reactions in the heat treatment process. When 300°C and 350°C were selected

as heat treatment temperatures, Ni<sub>3</sub>B formation was the main transition in the heat treatment process because these temperatures are below that of Ni<sub>2</sub>B formation. At 400°C, Ni<sub>3</sub>B and Ni<sub>3</sub>B formation was the main process, while after 500°C treatment, all the three kinds of borides appeared in the deposits. Therefore, the micro-hardness of deposits varied with their micro-structure and constitution, i.e. boride types and their congregation.

The main distinction between 300°C and 350°C treating processes was in the speed of Ni<sub>2</sub>B formation. When the treatment temperature was fixed at 300°C (Figure 4(a)), the crystallization reaction took place in a short time. As a result, a great deal of fcc Ni was generated in deposits. This improved the micro-hardness of the deposit greatly. As the duration extended further, the micro-hardness of deposit increased owing to Ni<sub>3</sub>B precipitation. When the heat treatment temperature reached to 350°C. more complicated changes were shown in the microhardness curve. Quite a high value was obtained just after 1 h treatment because of the rapidly forming fcc Ni. Then it decreased over 2 h duration due to the congregation of fcc Ni. But this trend was inhibited by Ni, B forming. As the amount of Ni,B increased, another maximal value of 1230 VHN<sub>100</sub> or so was obtained within 5~6 h. Then deposits were softened after longer duration, which is ascribed to the growth and congregation of borides. The value of micro-hardness kept nearly a constant beyond 7 h duration of heat treatment.

Variations of micro-hardness under 400°C and 500°C heat treatment are illustrated in Figure 4(b). Both of the two temperatures are higher than that of Ni<sub>3</sub>B and Ni<sub>3</sub>B formation, but differ in that 500°C is above the Ni.B. formation temperature. For the temperature 400°C, it is much higher than the temperature of Ni<sub>3</sub>B formation and just around the Ni<sub>3</sub>B formation temperature. Ni,B can be formed after a short duration, while Ni,B formation needs a long one. Thereby the curve for 400°C rises markedly before 1 h duration, for a large amount of Ni<sub>3</sub>B precipitation. Then the curve almost becomes level within 1 to 3 h duration. This may be ascribed to both the precipitation of Ni,B and congregation of Ni,B. Although the congregation of Ni<sub>3</sub>B lowers the microhardness, the increment of Ni,B in deposits compensates for this action. When the duration extended to 4~5 h, the microhardness came to a peak caused by the precipitation of a large amount of Ni,B. It seems that due to congregation of borides and Ni<sub>2</sub>B decomposition the micro-hardness of deposits decreases as a consequence of further long duration heat treatment. As for 500°C, the micro-hardness is higher than for all the three borides formation temperatures. Hence crystallizing proceeds strongly at this temperature, and nickel borides can be formed promptly. The micro-hardness curve reaches 1200 VHN<sub>100</sub> after only 0.5 h duration on account of Ni,B and Ni,B precipitating in the deposits. A peak occurs after 3 h duration corresponding to an increasing amount of borides. Compared to that of 400°C, this peak point advanced by two hours. It is also remarkable that the peak value in this figure

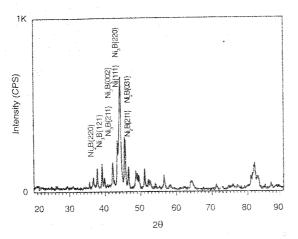


Figure 3(b). XRD pattern of a sample after  $400^{\circ}\text{C} \times 1$  h heat treatment.

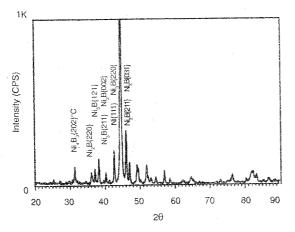


Figure 3(c). XRD pattern of a sample after  $500^{\circ}C \times 1$  h heat treatment

surpasses other temperatures, reaching 1400  $VHN_{\rm 100}$  . This is possibly due to  $Ni_4B_3$  precipitation.

To sum up the results above, it is evident that the changes of micro-hardness relate intimately with nickel borides formation. When borides appeared in deposits, microhardness increased markedly. Micro-hardness also related to the specific borides. It reached 1100~1200 VHN<sub>100</sub> with Ni<sub>3</sub>B existing in deposits, 1200~1300 VHN<sub>100</sub> with Ni<sub>2</sub>B, attaining 1400 VHN<sub>100</sub> with Ni<sub>4</sub>B<sub>3</sub>. Therefore the decline in micro-hardness after long duration of heat treatment is owing to some kind of borides disappearance in addition to borides congregation. For instance, the amount of Ni<sub>4</sub>B<sub>3</sub> decreases when the duration of heat treatment at 500°C exceeds 6 h (Figure 4(b)); very little Ni<sub>4</sub>B<sub>3</sub> is found in deposits after 10 h treatment. This is due to the unstability of these borides. From this figure, it can be also recognised that formation of nickel borides is determined not only by the heat treatment temperature, but also by its duration. If only

the duration is sufficient, Ni<sub>2</sub>B precipitation can take place at 300°C and 350°C which is below its forming temperature. A similar case occurred for Ni<sub>2</sub>B, at 400°C.

#### Natural Aging Phenomena after Heat Treatment and its Mechanism

Natural aging phenomena in deposits prepared under the current experimental conditions were discovered after some heat treatment processes. They are mainly reflected in variations of micro-hardness. Curves of microhardness in situ after some kinds of process and those after 5 and 25 days natural aging are shown in Figure 5. It can be seen from this figure that the natural aging trend is weak for treatment below 350°C. When the temperature fixed at 300°C, natural aging hardly occurred (Figure 5(a)). As for 350°C (Figure 5(b)), some extent of aging occurred after a very long duration. In contrast to these, natural aging phenonmena become rapid above 350°C. For instant, aging softening was severe even after a short duration 400°C treatment be concerned with the occurrence of metastable boride phases in deposits. It has been reported that Ni<sub>2</sub>B is a metastable compound. It probably transfers to the stable Ni<sub>2</sub>B or fcc Ni phase at room temperature, from XRD analysis. This suggests that natural aging phenomena in some cases in Figure 5 can be interpreted as Ni<sub>2</sub>B transferring to Ni<sub>3</sub>B or fcc Ni.

The aging softening mechanism of 500°C treatment (Figure 5(d)) differs somewhat from

(Figure 5(c)). These phenomena are thought to

The aging softening mechanism of 500°C treatment (Figure 5(d)) differs somewhat from that of 400°C. Besides transition of Ni<sub>2</sub>B, another key factor affecting aging in deposits is transformation of Ni<sub>4</sub>B<sub>3</sub>. This has been confirmed by XRD analysis. XRD patterns of coatings treated at 500°C for 3 h are shown in Figure 6. Figure 6(a) and (b) are patterns obtained immediately after 500°C treating and thereafter 5 days aging respectively. Comparing the two patterns, it is clear that the intensity of {111}Ni and {121}Ni<sub>3</sub>B peaks increases while that of the {200}Ni<sub>2</sub>B and {202}Ni<sub>4</sub>B<sub>3</sub> unlapped peaks decreases in Figure 6(b). This proves sufficiently that the decomposition of Ni<sub>2</sub>B and Ni<sub>4</sub>B<sub>3</sub> is the principal cause of natural aging.

It also can be found from Figure 5 that the maximal drop in micro-hardness appears in different places on different curves. These maximal points tend to shift in the long duration direction as the treatment temperature is lowered. For instant, the point on the 500°C curve locates at about 3 h, while 400°C is close to 5 h, 350°C close to 10 h. The maximal effect is of 500°C × 3 h. This is brought by Ni<sub>4</sub>B<sub>3</sub> decomposition because in this case Ni<sub>4</sub>B<sub>3</sub> is a key to improve micro-hardness in the deposit. When treated under 500°C, a great deal of Ni<sub>4</sub>B<sub>3</sub> was formed originally besides Ni<sub>4</sub>B and Ni<sub>4</sub>B. The natural aging occurring

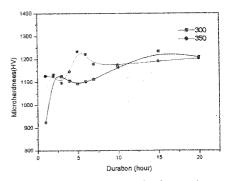


Figure 4(a). Variation of microhardness under different durations  $300^{\circ}\text{C}$  and  $350^{\circ}\text{C}$ .

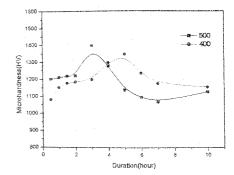
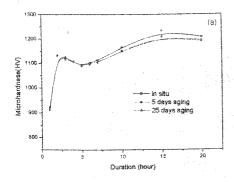
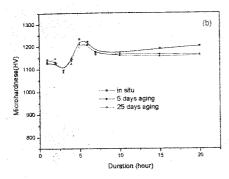


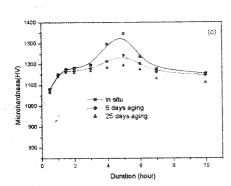
Figure 4(b). Variation of microhardness under different durations at  $400^{\circ}\text{C}$  and  $500^{\circ}\text{C}$ .

Table I. Schedule of Heat-treatment Processes

Temperature ${}^{\circ}\! {\mathbb C}$				Heat treatment time (hours)						
300 .	1	2	3	4	5	6	7	10	15	20 .
350	1	2	3	4	5	6	7	10	15	20
400	0.5	1	1.5	2	3	4	5	6	7	10
500	0.5	ĺ	1.5	2	3	4	5	6	7	10







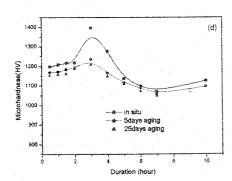


Figure 5. Influence of heat treatment processes and their 5 & 25 days natural aging on microhardness of deposits

- (a) Heat treat at 300°C
- (b) Heat treat at 350°C
- (c) Heat treat at 400°C
- (d) Heat treat at 500°C

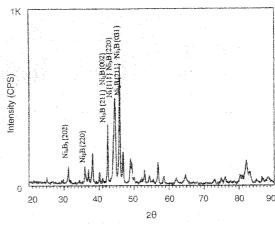


Figure 6(a). XRD pattern of a sample after  $500\% \times 3$  h heat treatment.

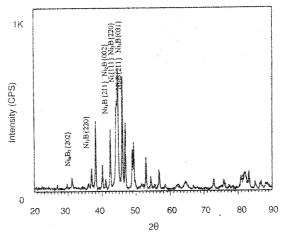


Figure 6(b). XRD pattern of the same sample after  $500\% \times 3$  h heat treatment and 5 days aging.

thereafter is caused not only by  $Ni_3B_4$  decomposition, but also chiefly by  $Ni_3B_4$  decomposition. Consequently, natural aging after  $500^{\circ}C$  treatment is most noticeable.

## CONCLUSIONS

- As-plated coatings with mixed microstructure of non-crystalline and boron supersaturated solid solution in nickel were prepared in the present research. Nickel borides such as Ni<sub>2</sub>B and Ni<sub>4</sub>B<sub>3</sub> were found following several different heat treatment processes.
- Nickel borides can be precipitated at the temperatures below their forming temperature as long as the duration is long enough. These borides are the key factors affecting coatings micro-hardness. The time necessary for a certain boride precipitation becomes shorter as higher treatment temperature is selected.
- A large amount of Ni<sub>4</sub>B<sub>3</sub>, which greatly improved coatings micro-hardness was found in deposits after 500°C heat treatment. It is a metastable phase, whose

- decomposition was found to occur at room temperature.
- Natural aging phenomena were found in deposits after some heat treatment processes. They were proved to be concerned with the decomposition of Ni<sub>2</sub>B and Ni<sub>4</sub>B<sub>3</sub>.

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